## $\square$ MN101C93 Series

| Type | MN101C93K | MN101CF93K |  |  |
| :--- | :---: | :---: | :---: | :---: |
| Internal ROM type | Mask ROM |  |  | FLASH |
| ROM (byte) | 224 K |  |  |  |
| RAM (byte) | 6 K |  |  |  |
| Package (Lead-free) | LQFP100-P-1414 |  |  |  |
| Minimum Instruction | $0.125 \mu \mathrm{~s}$ (at 3.0 V to $3.6 \mathrm{~V}, 8 \mathrm{MHzz}$ | $0.167 \mu \mathrm{~s}($ at $3.0 \mathrm{~V} \mathrm{to} 3.6 \mathrm{~V}, 6 \mathrm{MHz})$ |  |  |
| Execution Time | $62.5 \mu \mathrm{~s}$ (at 3.0 V to $3.6 \mathrm{~V}, 32 \mathrm{kHz}$ ) | $62.5 \mu \mathrm{~s}$ (at 3.0 V to $3.6 \mathrm{~V}, 32 \mathrm{kHz}$ ) |  |  |

## Interrupts

RESET. Watchdog. External 0 to 5 . External 6 (key interrupt dedicated). Timer 0 to 3. Timer 6. Timer 7 (2 systems). Timer 8 (2 systems). Time base. Serial 0 ( 2 systems). Serial 1 ( 2 systems). Serial 3 ( 1 systems). A/D conversion finish. Automatic transfer finish. USB interrupts

## Timer Counter

8 -bit timer $\times 5$
Timer 0 ... $\qquad$ .Square-wave/8-bit PWM output. Event count. Remote control carrier output. Simple pulse width measurement. Added pulse (2-bit) type PWM output. Square-wave/PWM output to large current terminal PC3 possible
Timer 1 $\qquad$ .Square-wave output. Event count. Serial transfer clock output. Synchronous output event
Timer 2 $\qquad$ .Square-wave output. Added pulse (2-bit) type PWM output. PWM output. Serial transfer clock output. Event count. Synchronous output event. Simple pulse width measurement. Square-wave/PWM output to large current terminal PC5 possible
Timer 3 $\qquad$ .Square-wave output. Event count. Serial transfer clock output
Timer 6 $\qquad$ .8-bit freerun timer
Timer 0,1 can be cascade-connected
Timer 2, 3 can be cascade-connected
16 -bit timer $\times 2$
Timer 7 . $\qquad$ Square-wave output. 16-bit PWM output (cycle/duty continuous variable). Event count. Synchronous output event. Pulse width measurement. Input capture. Real time output control. High performance IGBT output. Squarewave/PWM output to large current terminal PC4 possible
Timer 8 $\qquad$ .Square-wave/16-bit PWM output (duty continuous variable). Event count. Pulse width measurement. Input capture. Square-wave/PWM output to large current terminal PC6 possible
Timer 7, 8 can be cascade-connected: Square-wave output, PWM is possible as a 32 -bit timer
Time base timer: One-minute count setting
Watchdog timer $\times 1$

## Serial interface

Synchronous type/UART (full-duplex) $\times 2$ : Serial 0,1
Synchronous type/Single-master I² $\times 1$ : Serial 3

## DMA controller

Maximum transfer cycles: 255
Starting factor: External request. Various types of interrupt. Software
Transfer mode: 1-byte transfer. Word transfer. Burst transfer

## USB Functions

Conforms to USB 1.1: Full-speed ( 12 Mbps ) supported
USB transceiver built-in. 5 end points (FIFO built-in independently)
FIFO size: EP0 $=16$ bytes. $\mathrm{EP} 1=128$ bytes. $\mathrm{EP} 2=128$ bytes. $\mathrm{EP} 3=64$ bytes. $\mathrm{EP} 4=64$ bytes
EP0: Control transfer. IN/OUT (two ways)
EP1 to EP4: Interrupt/Bulk/Isochronous transfer supported. Settable to IN or OUT. Double Buffering function supported
When the MAXP size is set to a half or less of the MAXFIFO size for each EP, the Double Buffering function is made valid automatically

■ I/O Pins
I/O 84: Common use. Specified pull-up resistor available. Input/output selectable (bit unit)

## A/D converter

10 -bit $\times 12$ channels (with $\mathrm{S} / \mathrm{H}$ )

## Display control function

LCD: 47 segments $\times 4$ commons (Static, $1 / 2,1 / 3$, or $1 / 4$ duty)
LCD power supply separated from VDD (usable if $\mathrm{VDD}=\mathrm{VLCD} \leq 3.6 \mathrm{~V}$ )
LCD power shunt resistance contained

## Special Ports

USB ports ( $\mathrm{D}+, \mathrm{D}-$ ). Buzzer output. Inverted buzzer output. Remote control carrier output. High-current drive port. Clock output

## - Pin Assignment

LQFP100-P-1414


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